

10/540528

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**Application Data Sheet**

**Application Information**

|                                  |  |
|----------------------------------|--|
| Application Type::               | Regular  |
| Subject Matter::                 | National Phase                                 |
| Suggested Group Art Unit::       | N/A  |
| CD-ROM or CD-R?::                | None   |
| Sequence submission?::           | None   |
| Computer Readable Form (CRF)?::  | No   |
| Title::                          | CURABLE RESIN COMPOSITION AND<br>CURED PRODUCT |
| Attorney Docket Number::         | 4924-0112PUS1                                  |
| Request for Early Publication?:: | No   |
| Request for Non-Publication?::   | No   |
| Small Entity?::                  | No   |
| Petition included?::             | No   |
| Secrecy Order in Parent Appl.?:: | No   |

**Applicant Information**

|   |                       |
|---|-----------------------|
| Applicant Authority Type::              | Inventor              |
| Primary Citizenship Country::           | Japan                 |
| Status::                                | Full Capacity         |
| Given Name::                            | Hisashi               |
| Family Name::                           | MAESHIMA              |
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| Country of Residence::                  | Japan                 |
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**Correspondence Information**

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Correspondence Customer Number:: 02292

**Representative Information**

Representative Customer Number:: 02292

**Domestic Priority Information**

| Application::            | Continuity Type:: | Parent Application:: | Parent Filing Date:: |
|--------------------------|-------------------|----------------------|----------------------|
| This Application is<br>a | National Stage of | PCT/JP2003/016568    | 12/24/03             |

**Foreign Priority Information**

| Country:: | Application number:: | Filing Date:: | Priority Claimed:: |
|-----------|----------------------|---------------|--------------------|
| Japan     | 2002-381563          | 12/27/02      | Yes                |

**Assignee Information**

Assignee name:: Daicel Chemical Industries, Ltd.  
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